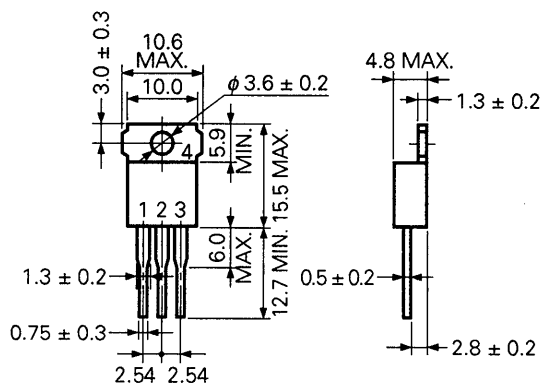


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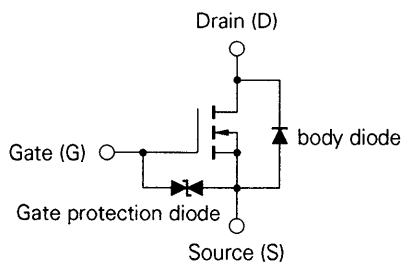
P1 98.2

SWITCHING
N-CHANNEL POWER MOS FET
INDUSTRIAL USE

PACKAGE DIMENSIONS
(in millimeters)



1. Gate
2. Drain
3. Source
4. Fin (Drain)



DESCRIPTION

The 2SK1287 is N-channel MOS Field Effect Transistor designed for solenoid, motor and lamp driver.

FEATURES

- Low On-state Resistance
 $R_{DS(on)} \leq 70 \text{ m}\Omega \text{ MAX. (} V_{GS} = 10 \text{ V, } I_D = 10 \text{ A)}$
 $R_{DS(on)} \leq 95 \text{ m}\Omega \text{ MAX. (} V_{GS} = 4 \text{ V, } I_D = 10 \text{ A)}$
- Low C_{iss} $C_{iss} = 1\,400 \text{ pF TYP.}$
- Built-in G-S Gate Protection Diodes

QUALITY GRADE

Standard

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

ABSOLUTE MAXIMUM RATINGS

Maximum Temperatures

Storage Temperature	-55 to +150	°C
Channel Temperature	150	°C MAX.

Maximum Power Dissipation

Total Power Dissipation ($T_a = 25 \text{ }^\circ\text{C}$)	1.5	W
Total Power Dissipation ($T_c = 25 \text{ }^\circ\text{C}$)	60	W

Maximum Voltages and Currents ($T_a = 25 \text{ }^\circ\text{C}$)

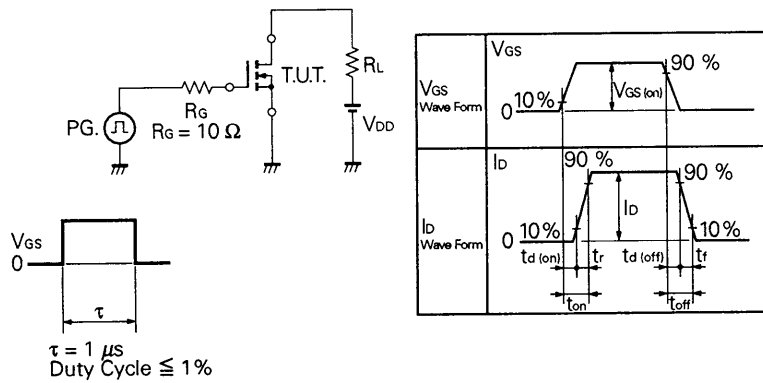
V_{DSS}	Drain to Source Voltage	60	V
$V_{GSS(AC)}$	Gate to Source Voltage	± 20	V
$I_{D(DC)}$	Drain Current (DC)	± 15	A
$I_{D(pulse)*}$	Drain Current (pulse)	± 80	A

* $PW \leq 10 \text{ } \mu\text{s}$, Duty Cycle $\leq 1 \%$

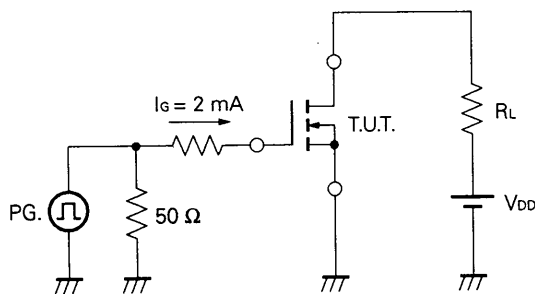
ELECTRICAL CHARACTERISTICS (T_a = 25 °C)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-state Resistance	R _{DS(on)}		55	70	mΩ	V _{GS} = 10 V, I _D = 10 A
Drain to Source On-state Resistance	R _{DS(on)}		80	95	mΩ	V _{GS} = 4.0 V, I _D = 10 A
Gate to Source Cutoff Voltage	V _{GS(off)}	1.0		2.5	V	V _{DS} = 10 V, I _D = 1 mA
Forward Transfer Admittance	y _{fs}	7.0	14		S	V _{DS} = 10 V, I _D = 10 A
Drain Leakage Current	I _{DSS}			10	μA	V _{DS} = 60 V, V _{GS} = 0
Gate to Source Leakage Current	I _{GSS}			±10	μA	V _{GS} = ±20 V, V _{DS} = 0
Input Capacitance	C _{iss}		1 400		pF	V _{DS} = 10 V
Output Capacitance	C _{oss}		500		pF	V _{GS} = 0
Reverse Transfer Capacitance	C _{rss}		130		pF	f = 1 MHz
Turn-On Delay Time	t _{d(on)}		25		ns	V _{GS(on)} = 10 V
Rise Time	t _r		160		ns	V _{DD} = 30 V
Turn-Off Delay Time	t _{d(off)}		130		ns	I _D = 10 A, R _G = 10 Ω
Fall Time	t _f		80		ns	R _L = 3.0 Ω
Total Gate Charge	Q _G		30		nC	V _{GS} = 10 V
Gate to Source Charge	Q _{GS}		5		nC	I _D = 20 A
Gate to Drain Charge	Q _{GD}		10		nC	V _{DD} = 48 V
Diode Forward Voltage	V _{SD}		1.0		V	I _{SD} = 20 A, V _{GS} = 0
Reverse Recovery Time	t _{rr}		150		ns	I _F = 20 A, V _{GS} = 0
Reverse Recovery Charge	Q _{rr}		250		nC	di/dt = 50 A/μs

Test Circuit 1: Switching Time

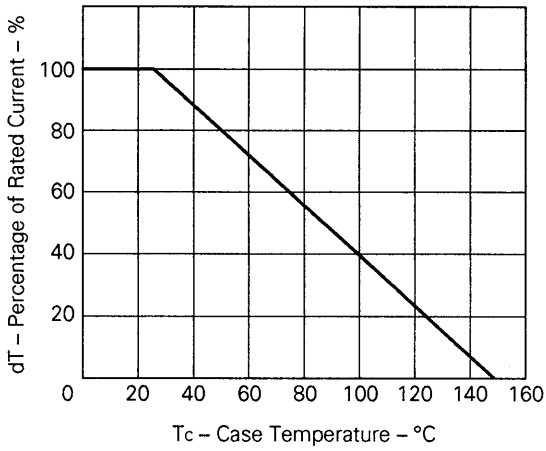


Test Circuit 2: Gate Charge

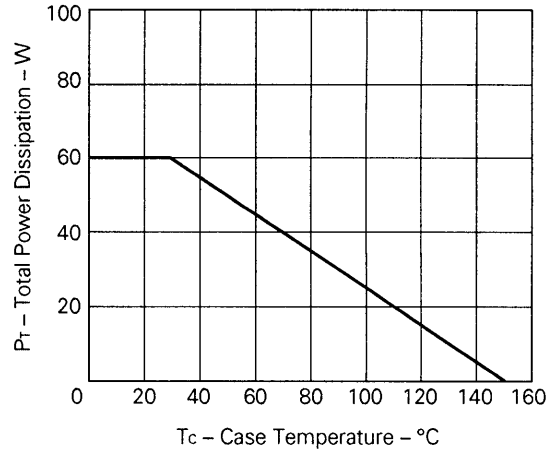


TYPICAL CHARACTERISTICS ($T_a = 25\text{ }^\circ\text{C}$)

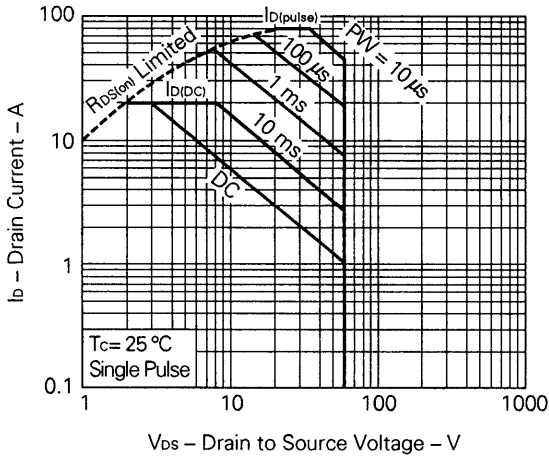
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



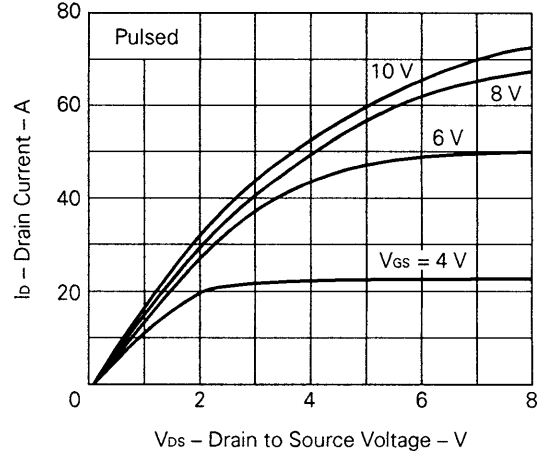
TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



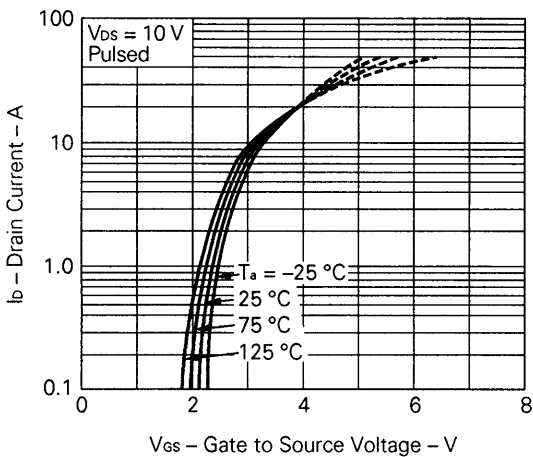
FORWARD BIAS SAFE OPERATING AREA

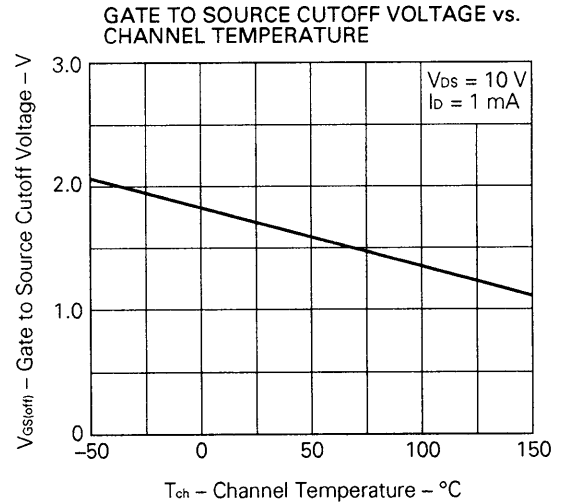
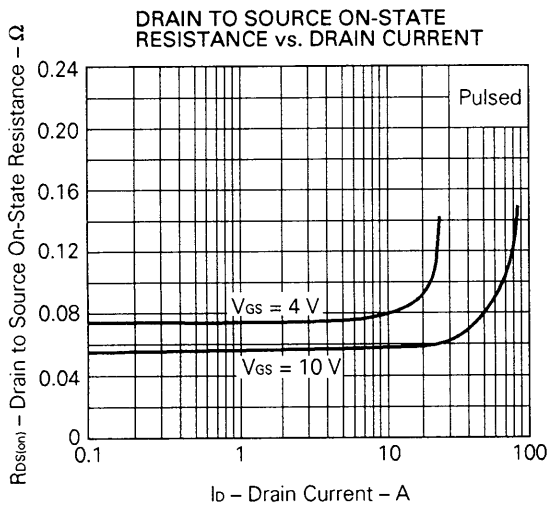
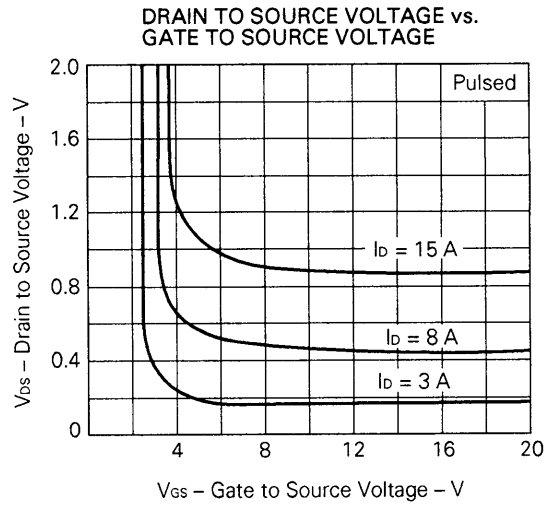
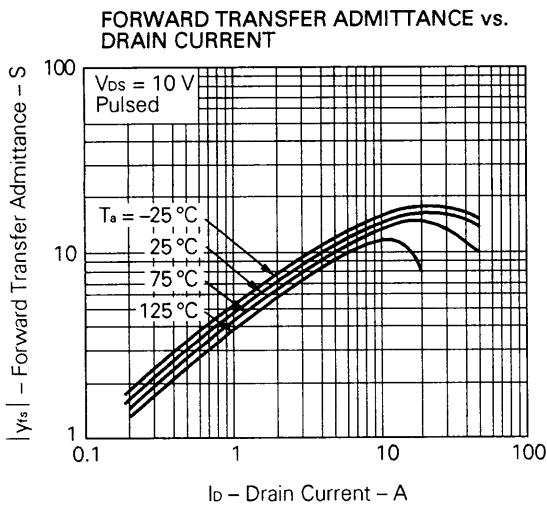
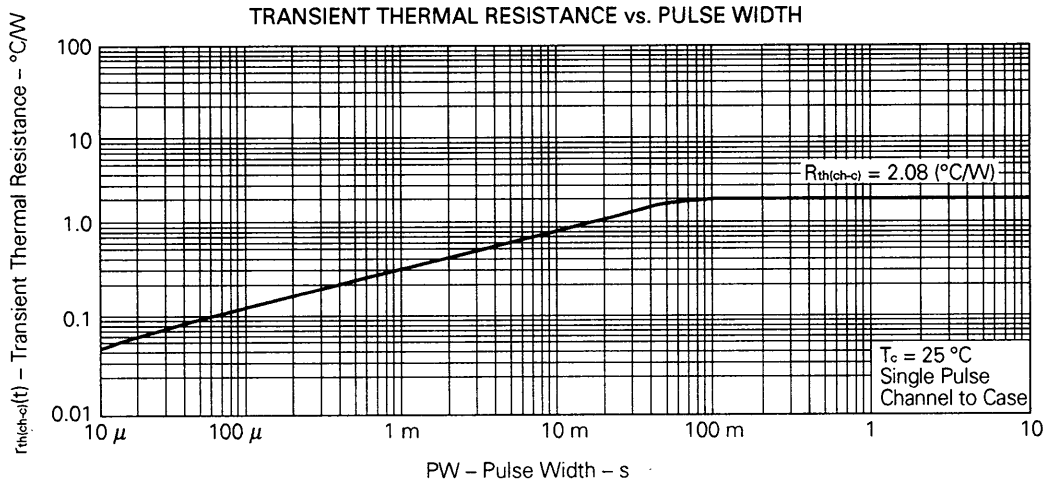


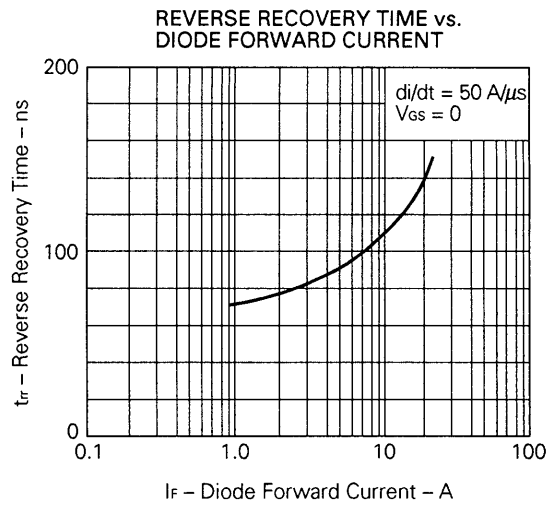
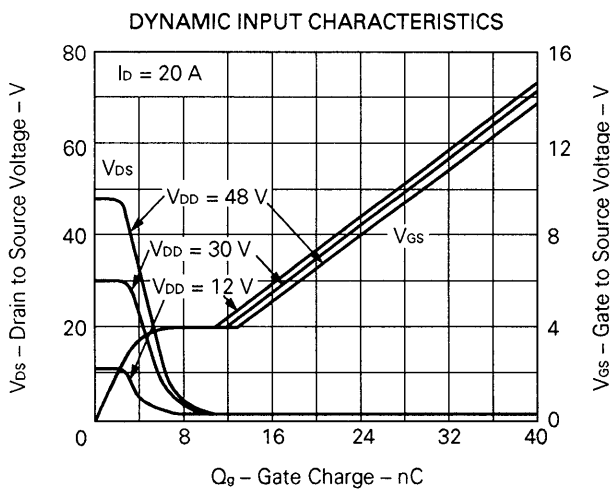
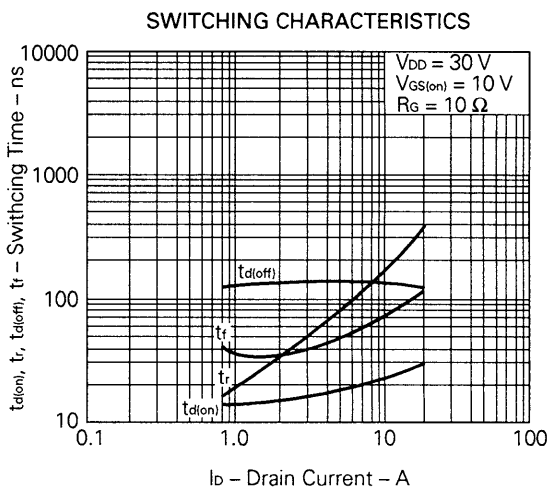
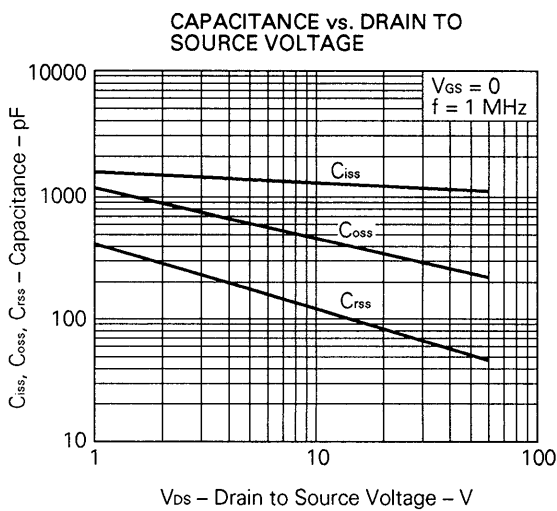
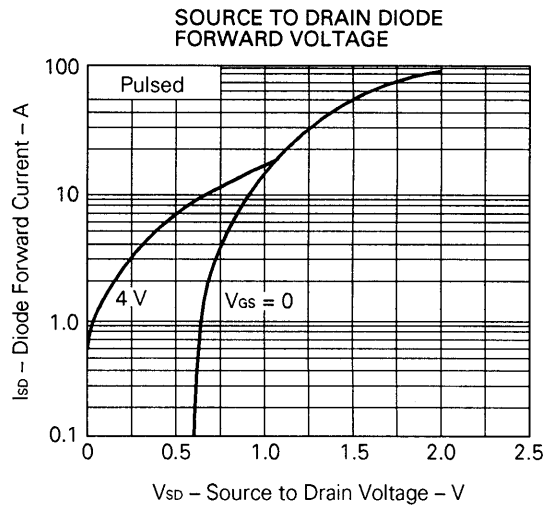
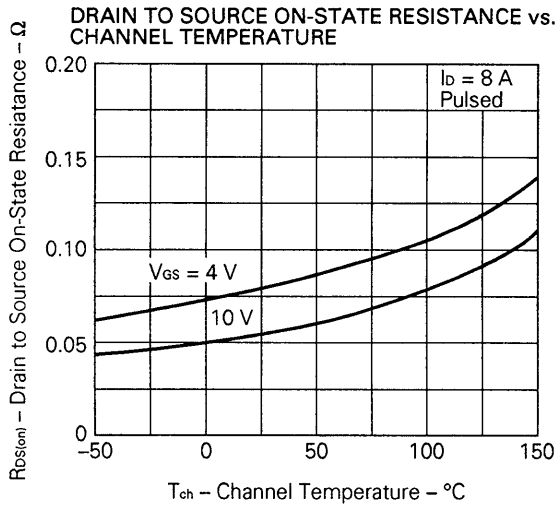
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



TRANSFER CHARACTERISTICS







Reference

Application note name	No.
Safe operating area of Power MOS FET.	TEA-1034
Application circuit using Power MOS FET.	TEA-1035
Quality control of NEC semiconductors devices.	TEI-1202
Quality control guide of semiconductors devices.	MEI-1202
Assembly manual of semiconductors devices.	IEI-1207

[MEMO]

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